# **UF3A THRU UF3M**



# SURFACE MOUNT ULTRAFAST RECOVERY RECTIFIER

REVERSE VOLTAGE: 50 to 1000 VOLTS http://www.njzrg.com
FORWARD CURRENT: 3.0 AMPERE

#### **FEATURES**

- · For surface mounted applications
- · Low profile package
- · Built-in strain relief
- · Easy pick and place
- · Ultrafast recovery times for high efficiency
- · Plastic package has Underwriters Laboratory

Flammability Classification 94V-O

· High temperature soldering : 260°C /10 seconds at terminals

### **MECHANICAL DATA**

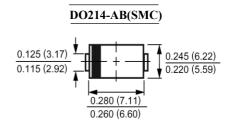
Case: Molded plastic, DO-214AB(SMC)

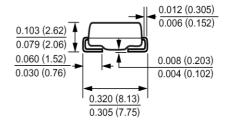
Terminals: Solder plated, solderable per MIL-STD-750,

method 2026 guaranteed

Polarity: Color band denotes cathode end Packaging: 16mm tape per EIA STD RS-481

Weight: 0.007 ounce, 0.21 gram





**Dimensions in inches and (millimeters)** 

## Maximum Ratings and Electrical Characteristics

Ratings at 25 ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	UF3A	UF3B	UF3D	UF3G	UF3J	UF3K	UF3M	Units
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current	I <sub>(AV)</sub> 3.0							Amn	
at T <sub>L</sub> =75	I <sub>(AV)</sub>	3.0							Amp
Peak Forward Surge Current,									
8.3ms single half-sine-wave	$I_{FSM}$	I <sub>FSM</sub> 100							Amp
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage at 3.0A	$V_{\rm F}$		1.0		1.3		1.7		Volts
Maximum Reverse Current at T <sub>A</sub> =25	$I_R$	5.0							μAmp
at Rated DC Blocking Voltage T <sub>A</sub> =100	1R	300							
Typical Junction Capacitance (Note 1)	$C_{\mathbf{J}}$	75 63						pF	
Typical Thermal Resistance (Note 2)	$R_{\theta JL}$	15							/W
Maximum Reverse Recovery Time (Note 3)	$T_{RR}$	50 75					75		nS
Operating Junction Temperature Range	$T_{\mathbf{J}}$	-55 to +150							
Storage Temperature Range	Tstg	-55 to +150							

#### **NOTES:**

- 1- Measured at 1 MHz and applied reverse voltage of 4.0 VDC.
- 2- Thermal resistance from junction to lead mounted on P.C.B. with 0.3 x 0.3" (8.0 x 8.0mm) copper pad areas
- 3- Reverse Recovery Test Conditions :  $I_F$ =.5A ,  $I_R$ =1A ,  $I_{RR}$ =.25A.



http://www.njzrg.com

#### RATINGS AND CHARACTERISTIC CURVES

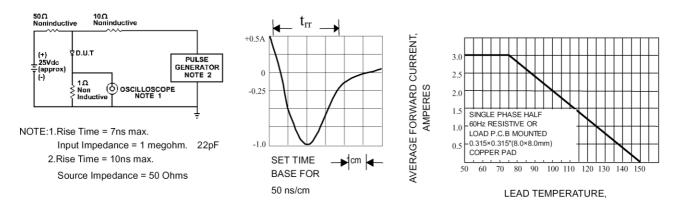


Fig. 1-REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM

Fig. 2-MAXIMUM AVERAGE FORWARD CURRENT RATING

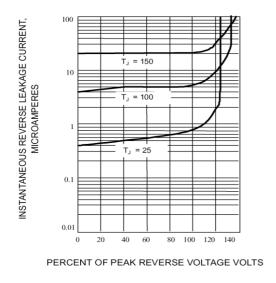


Fig. 3-TYPICAL REVERSE CHARACTERISTICS

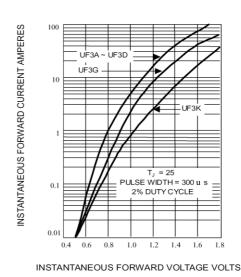


Fig. 4-TYPICAL FORWARD CHARACTERISTICS

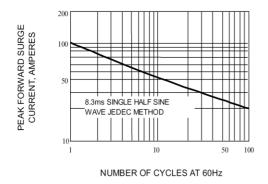


Fig. 5-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

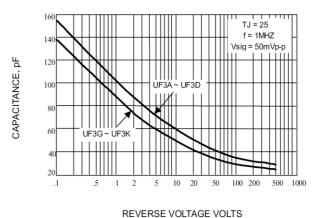


Fig. 6-TYPICAL JUNCTION CAPACITANCE